

4-11-05

Docket No.: FP05-073US

FORM PTO-159F (Modified)
(Rev. 03-01)
OMB No. 0851-0027 (exp. 5/31/2002)
P08A/REV03

04-22-2005

COVER SHEET

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

LY



102986991

Tab settings

To the Director of the United States Patent and Trademark Office

Record the attached original documents or copy thereof.

1. Name of conveying party(ies):
Hitoshi Takanashi

2. Name and address of receiving party(ies):

Name: **Sumitomo Wiring Systems, Ltd.**

Address: **1-14, Nishisuehiro-cho**

Additional names(s) of conveying party(ies) Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

City: **Yokkaichi-City** State/Prov.: **Mie**

Country: **Japan** ZIP: **510-8503**

Execution Date: **April 8, 2005**

Additional name(s) & address(es) Yes No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: **April 8, 2005**

Patent Application No.	Filing date	B. Patent No.(s)
------------------------	-------------	------------------

Additional numbers Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Gerald E. Hespos**

Registration No. **30,066**

Address: **274 Madison Avenue - Suite 1703**

City: **New York** State/Prov.: **NY**

Country: **USA** ZIP: **10016**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41):.....\$ **40.00**

- Enclosed - Any excess or insufficiency should be credited or debited to deposit account
- Authorized to be charged to deposit account

8. Deposit account number:

03-1030

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Gerald E. Hespos, Esq.
Name of Person Signing

Gerald E. Hespos
Signature

April 11, 2005
Date

2

04/21/2005 DRYRNE 00000227 031030 102986991 Number of pages including cover sheet, attachments, and

Mail documents to be recorded with required cover sheet information to:
Mail Stop Assignment Recordation Services
Director of the United States Patent and Trademark Office
P.O. Box 1450, Alexandria, VA 22313-1450

01 FC:8021

40.00 DA

PATENT
REEL: 016472 FRAME: 0879

112963 U.S. PTO
11/103833
041105

Atty. Ref.: FP05-073US

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignee, Sumitomo Wiring Systems, Ltd., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503 Japan, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers and sets over unto the said assignee the entire right, title and interest in and to the invention or improvement entitled "AN INSERT-MOLDED ARTICLE AND A PRODUCTION METHOD FOR INSERT-MOLDED ARTICLE", said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee Is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries at its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patents which may be granted therefor in said Assignee, its successors, assigns or other legal representatives, and, upon the request and at the expense of said assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of any Letters Patents to be granted therefor, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein, without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

And The Commissioner Of Patents Is Hereby Authorized And Requested to issue any and all Letters Patent of the United States for said invention, to said assignee.

April 8, 2005
Date

Hitoshi Takanashi
Hitoshi Takanashi